

FDN86501LZ N-Channel Shielded Gate PowerTrench[®] MOSFET

60 V, 2.6 A, 116 mΩ

Features

- Shielded Gate MOSFET Technology
- Max r_{DS(on)} = 116 mΩ at V_{GS} = 10 V, I_D = 2.6 A
- Max r_{DS(on)} = 173 mΩ at V_{GS} = 4.5 V, I_D = 2.1 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL tested
- RoHS Compliant

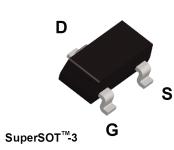


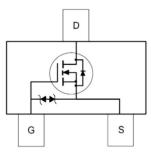
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- Primary DC-DC Switch
- Load Switch





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Parameter	Ratings	Units	
V _{DS}	Drain to Source Voltage		60	V
V _{GS}	Gate to Source Voltage		±20	V
ID	-Continuous	(Note 1a)	2.6	
	-Pulsed	(Note 4)	24	— A
E _{AS}	Single Pulse Avalanche Energy (Note 3)		6	mJ
P _D	Power Dissipation(Note 1a)Power Dissipation(Note 1b)		1.5	
			0.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C	

Thermal Characteristics

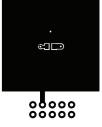
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	80	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
8650	FDN86501LZ	SSOT-3	7 "	8 mm	3000 units

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Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	60			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		68		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±10	μA
On Chara	cteristics (Note 2)					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.0	1.9	2.4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-5		mV/°C
0		V _{GS} = 10 V, I _D = 2.6 A		89	116	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 4.5 V, I _D = 2.1 A		121	173	mΩ
		V_{GS} = 10 V, I _D = 2.6 A, T _J = 125 °C		152	198	
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 2.6 A		8		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	– V _{DS} = 30 V, V _{GS} = 0 V,		236	335	pF
C _{oss}	Output Capacitance	v _{DS} = 30 v, v _{GS} = 0 v, —f = 1 MHz		77	110	pF
C _{rss}	Reverse Transfer Capacitance			4.9	10	pF
R _g	Gate Resistance		0.1	0.8	2.0	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			4.4	10	ns
t _r	Rise Time	V _{DD} = 30 V, I _D = 2.6 A,		1.2	10	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		9.6	20	ns
t _f	Fall Time			1.2	10	ns
Qg	Total Gate Charge	V_{GS} = 0 V to 10 V		3.8	5.4	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 30 V,$		1.9	2.7	nC
Q _{gs}	Gate to Source Gate Charge	I _D = 2.6 A		0.7		nC
Q _{gd}	Gate to Drain "Miller" Charge			0.6		nC
Drain-Soເ	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.9	1.3	V
t _{rr}	Reverse Recovery Time	—I _F = 2.6 A, di/dt = 100 A/μs		31	50	ns
Q _{rr}	Reverse Recovery Charge	F = 2.0 A, ui/ut = 100 A/μS		19	31	nC



2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

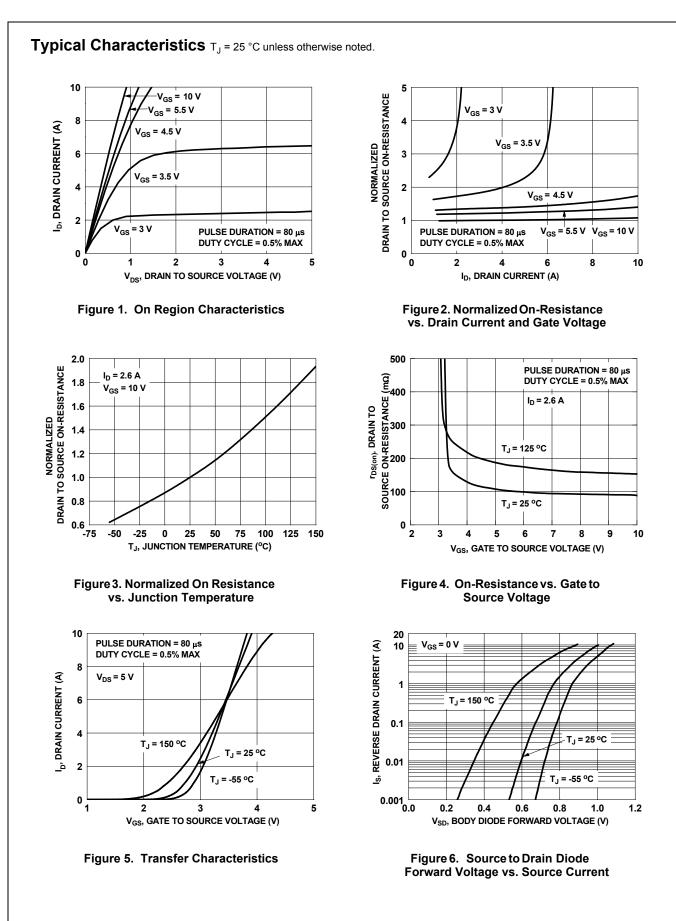
4. Pulsed Id please refer to Fig 11 SOA graph for more details.

a) 80 °C/W when mounted on a 1 in² pad of 2 oz copper

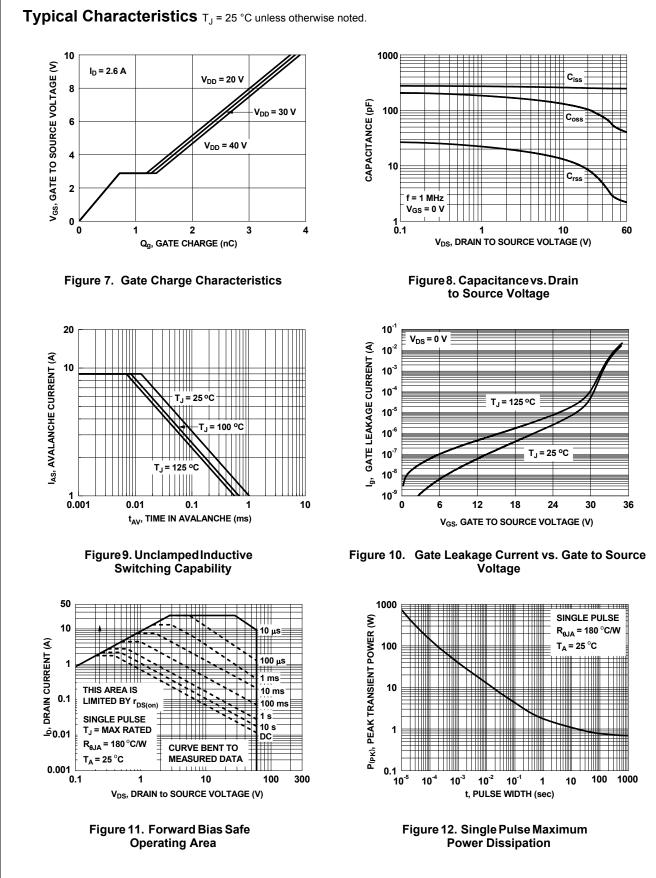
3. E_{AS} of 6 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 2 A, V_{DD} = 60 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 9 A.



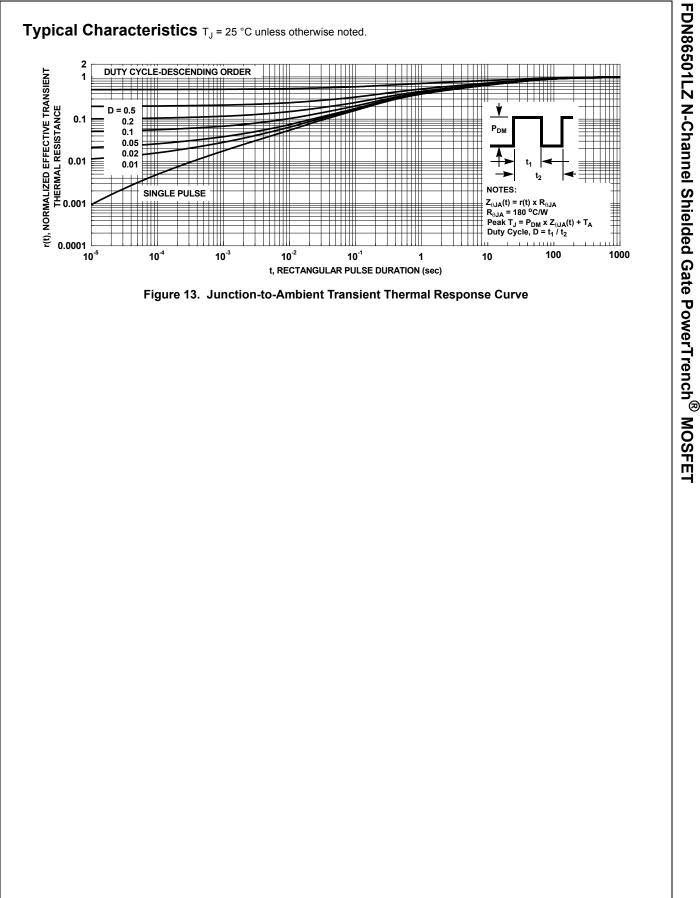
b) 180 °C/W when mounted on a minimum pad.

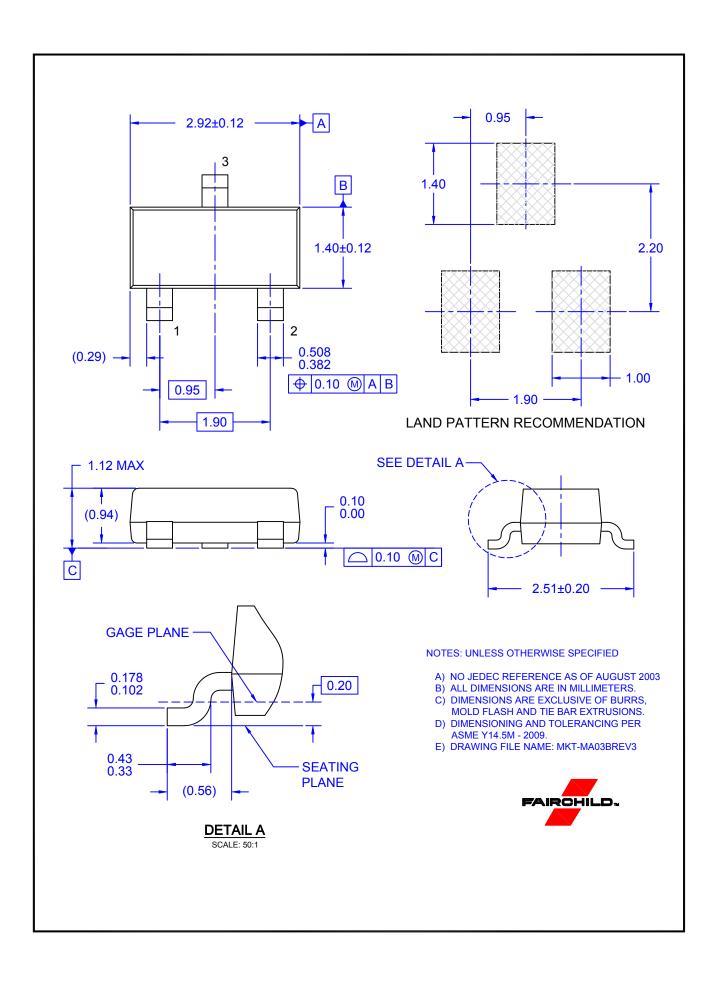


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